November 2nd, 2010

# International Rectifier

## Automotive Grade AUIRS2004S

HALF-BRIDGE DRIVER IC

#### **Features**

- Floating channel designed for bootstrap operation
- Fully operational to +200 V
- Tolerant to negative transient voltage dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout
- 3.3 V, 5 V, and 15 V logic compatible
- Cross-conduction prevention logic
- · Internally set deadtime
- · High-side output in phase with input
- Shutdown input turns off both channels
- Matched propagation delay for both channels
- RoHS Compliant
- Automotive qualified\*

#### **Typical Applications**

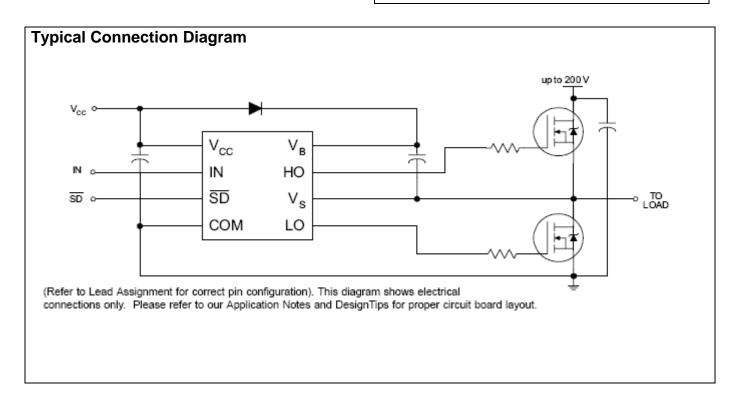
- Motor/Pump Drives
- DC-DC Converters

**Product Summary** 

V <sub>OFFSET</sub>	≤ 200V
V <sub>OUT</sub>	10 – 20V
I <sub>o+</sub> & I <sub>o-</sub> (typical)	130mA & 270mA
t <sub>ON</sub> & t <sub>OFF</sub> (typical)	680 ns/150 ns
Deadtime (typical)	520 ns

**Package Options** 





## **AUIRS2004S**



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AUIRS2004S

## International **IOR** Rectifier

## **Description**

The AUIRS2004S is a high voltage, high speed power MOSFET and IGBT driver with dependent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive N-channel power MOSFET or IGBT in the high side configuration which operates from 10V to 200 volts.



### **Qualification Information**<sup>†</sup>

Qualification Level		Automotive (per AEC-Q100 <sup>††</sup> )		
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.		
Moisture Sensitivity Level		MSL3 <sup>†††</sup> 260°C (per IPC/JEDEC J-STD-020)		
	Machine Model	Class M2 (+/-200V) (per AEC-Q100-003)		
ESD	Human Body Model	Class H1C (+/-2000V) (per AEC-Q100-002)		
Charged Device Model		Class C4 (+/-1000V) (per AEC-Q100-011)		
IC Latch-Up Test		Class II, Level B †††† (per AEC-Q100-004)		
RoHS Compliant		Yes		

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- †† Exceptions to AEC-Q100 requirements are noted in the qualification report.
- ††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.
- †††† LIN and HIN stressed to +/-20mA



#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which permanent damage to the device may occur. These are stress ratings only, functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Condition" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
$V_{B}$	High Side Floating Supply Voltage	-0.3	225	
Vs	High Side Floating Offset Voltage	V <sub>B</sub> - 20	V <sub>B</sub> + 0.3	
$V_{HO}$	High Side Floating Output Voltage	V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3	
V <sub>CC</sub>	Low Side and Logic Fixed Supply Voltage	-0.3	25	
$V_{LO}$	Low Side Output Voltage	-0.3	V <sub>CC</sub> + 0.3	V
V <sub>IN</sub>	Logic Input Voltage ( IN, SD)	V <sub>SS</sub> -0.3	V <sub>cc</sub> + 0.3	
dV <sub>S</sub> /dt	Allowable Offset Supply Voltage Transient		50	V/ns
P <sub>D</sub>	Package Power Dissipation @ TA ≤ +25 °C	_	0.625	W
Rth <sub>JA</sub>	Thermal Resistance, Junction to Ambient	_	200	°C/W
$T_J$	Junction Temperature		150	
Ts	Storage Temperature	-55	150	°C
$T_L$	Lead Temperature (soldering, 10 seconds)		300	

## **Recommended Operating Conditions**

The Input/Output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. All voltage parameters are absolute voltage referenced to COM. The  $V_S$  offset rating is tested with all supplies biased at 15 V differential.

Symbol	Definition	Min.	Max.	Units
$V_B$	High Side Floating Supply Voltage	V <sub>S</sub> +10	V <sub>S</sub> +20	
Vs	Static High side floating offset voltage	Note1	200	
$V_{HO}$	High Side Floating Output Voltage	Vs	$V_B$	.,
$V_{CC}$	Low Side and Logic Fixed Supply Voltage	10	20	V
$V_{LO}$	Low Side Output Voltage	0	$V_{CC}$	
$V_{IN}$	Logic Input Voltage (IN & SD)	0	V <sub>CC</sub>	
$T_A$	Ambient temperature	-40	125	°C

**Note 1:** Logic operational for  $V_S$  of -5 V to +200 V. Logic state held for  $V_S$  of -5 V to  $-V_{BS}$ .



## **Dynamic Electrical Characteristics**

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C  $\leq$  Tj  $\leq$ 125°C with bias conditions of V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15 V, C<sub>L</sub> = 1000 pF.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions
t <sub>on</sub>	Turn-on propagation delay		680	880		V <sub>S</sub> = 0 V
t <sub>off</sub>	Turn-off propagation delay		150	220		V <sub>S</sub> = 200 V
tr	Turn-on rise time	_	160	220		
t <sub>f</sub>	Turn-off fall time	_	70	170		
DT <sub>25</sub>	Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off	400	520	650	ns	Tj=25^C
DT	Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off	400		800		
MT <sub>25</sub>	Delay matching HS & LS turn-on/off	_	_	80		Tj=25^C
MT	Delay matching HS & LS turn-on/off		_	150		

## **Static Electrical Characteristics**

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C  $\leq$  Tj  $\leq$  125°C with bias conditions of V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15 V. The V<sub>IN</sub>, V<sub>TH</sub> and I<sub>IN</sub> parameters are referenced to COM. The V<sub>O</sub> and I<sub>O</sub> parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

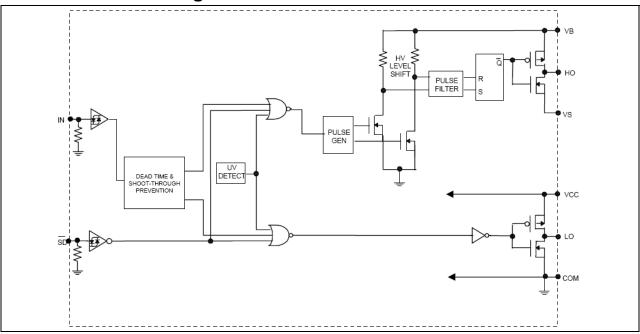
Symbol	Definition		Тур	Max	Units	Test Conditions
$V_{IH}$	Logic "1" (HO) & Logic "0" (LO) input Voltage	2.5	_			
V <sub>IL</sub>	Logic "0" (HO) & Logic "1" (LO) input Voltage		_	0.8		V <sub>CC</sub> = 10 V to 20 V
$V_{SD,TH+}$	SD Input Positive Going Threshold	2.5				V <sub>CC</sub> = 10 V to 20 V
V <sub>SD,TH-</sub>	SD Input Negative Going Threshold			0.8	V	
V <sub>OH</sub>	High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	_	0.05	0.2		1 = 2 m A
V <sub>OL</sub>	Low Level Output Voltage, Vo	_	0.02	0.1		I <sub>O</sub> = 2 mA
I <sub>LK</sub>	Offset Supply Leakage Current	_		50		V <sub>B</sub> = V <sub>S</sub> = 200 V
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	_	30	55		V <sub>IN</sub> = 0 V or 5 V
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current	_	150	270		
I <sub>IN+</sub>	Logic "1" Input Bias Current		3	10	μA	V <sub>IN</sub> = 5 V
I <sub>IN-</sub>	Logic "0" Input Bias Current			5		V <sub>IN</sub> = 0 V
I <sub>SD+</sub>	Bias Current at SD pin, shut down disabled		3	10		SD pin = 5 V
$I_{SD-}$	Bias Current at SD pin, shut down enabled			5		SD pin = 0 V
V <sub>CCUV+</sub>	V <sub>CC</sub> Supply Undervoltage Positive going Threshold	8	8.9	9.8	V	
V <sub>CCUV-</sub>	V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	7.4	8.2	9	V	
I <sub>O+</sub>	Output High Short Circuit Pulsed Current	130	290		mA	$V_O = 0 V$ , PW $\leq 10 us$
I <sub>O-</sub>	Output Low Short Circuit Pulsed Current	270	600		IIIA	V <sub>O</sub> = 15 V, PW ≤ 10 us

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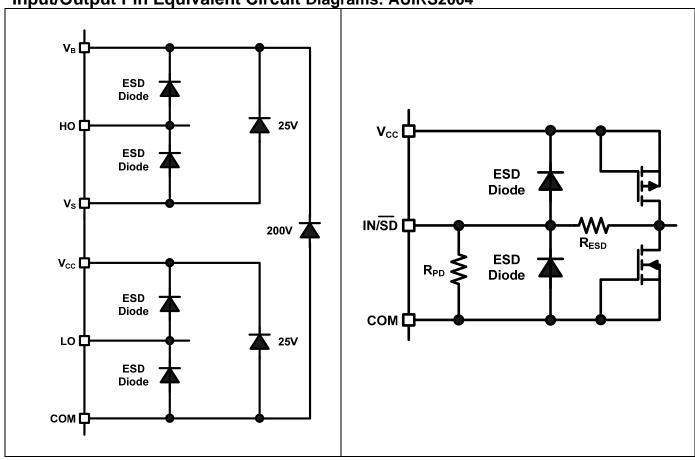
Rectifier

## **AUIRS2004S**

## **Functional Block Diagram**



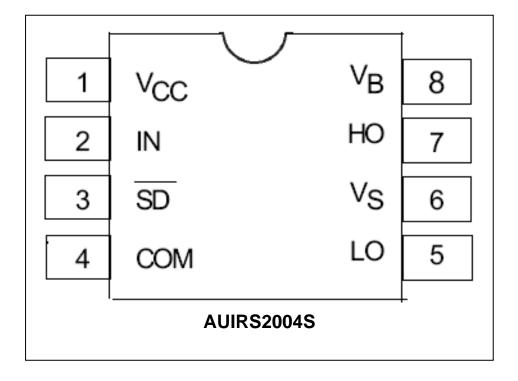
Input/Output Pin Equivalent Circuit Diagrams: AUIRS2004



## **Lead Definitions**

Symbol	Description
IN	Logic input for high side and low side gate driver outputs (HO and LO), in phase with HO
SD	Logic input for shutdown
$V_B$	High side floating supply
НО	High side gate drive output
Vs	High side floating supply return
$V_{CC}$	Low side and logic fixed supply
LO	Low side gate drive output
COM	Low side return

## **Lead Assignments**



## **Application Information and Additional Details**

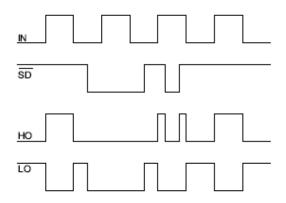
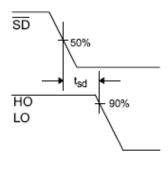
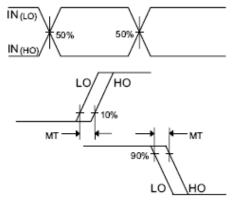


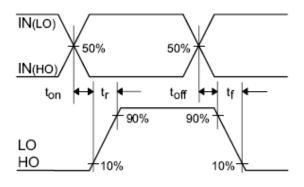
Figure 1: Input/Output Timing Diagram



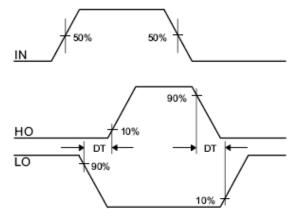
**Figure3: Shutdown Waveform Definitions** 



**Figure 5: Delay Matching Waveform Definitions** 



**Figure 2: Switching Time Waveform Definitions** 

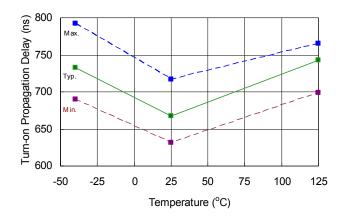


**Figure 4: Deadtime Waveform Definitions** 



#### **Parameter Temperature Trends**

Figures illustrated in this chapter provide information on the experimental performance of the AUIRS2004S HVIC. The line plotted in each figure is generated from actual lab data. A large number of individual samples were tested at three temperatures (-40 °C, 25 °C, and 125 °C) in order to generate the experimental curve. The line consists of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the Typ. curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).



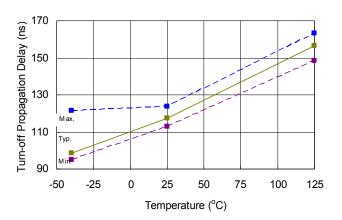
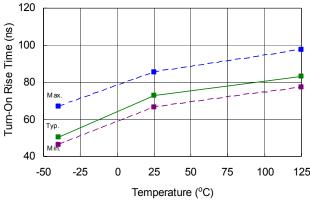
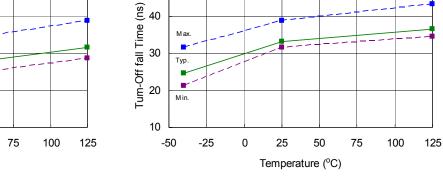


Figure 6: Ton vs. temperature

Figure 7: T<sub>OFF</sub> vs. temperature

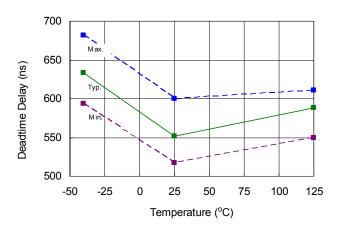




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Figure 8: T<sub>R</sub> vs. temperature

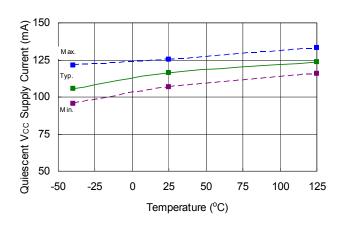
Figure 9: T<sub>F</sub> vs. temperature



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Figure 10: Deadtime vs. temperature

Figure 11: Offset Leakage Current vs. temperature



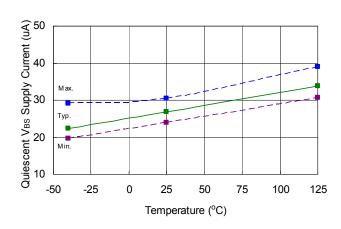
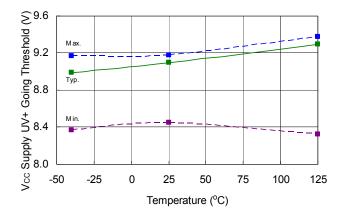


Figure 12: V<sub>CC</sub> Supply Current vs. Temperature

Figure 13: V<sub>BS</sub> Supply Current vs. temperature



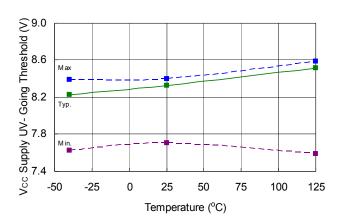
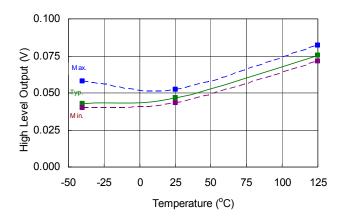


Figure 14: V<sub>CCUV+</sub> vs. temperature

Figure 15: V<sub>CCUV</sub>. vs. temperature



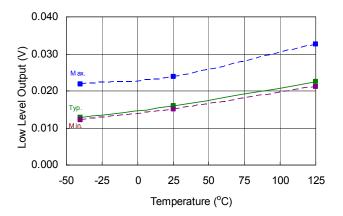
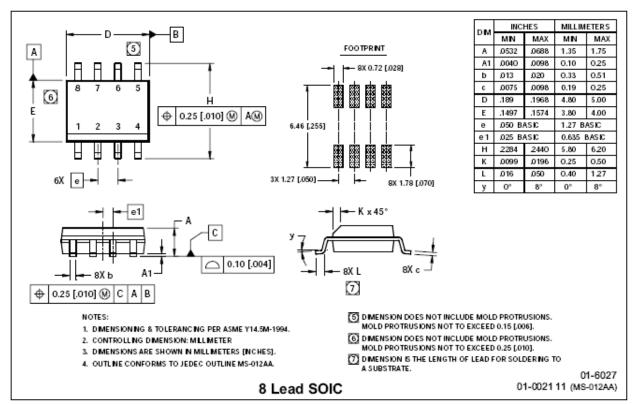


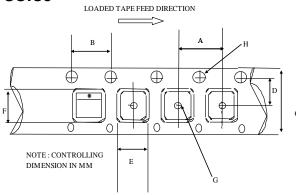
Figure 16:  $V_{OH}$  ( $I_O = 2mA$ ) vs. temperature

Figure 17:  $V_{OL}$  ( $I_O = 2mA$ ) vs. temperature

### **Case Outlines**

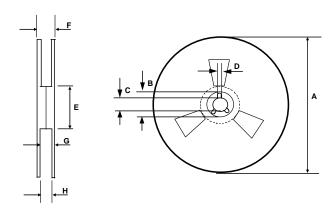


## **Tape and Reel Details: SOIC8**



CARRIER TAPE DIMENSION FOR 44PLCC

	Metric		Imp	erial
Code	Min	Max	Min	Max
Α	23.90	24.10	0.94	0.948
В	3.90	4.10	0.153	0.161
С	31.70	32.30	1.248	1.271
D	14.10	14.30	0.555	0.562
E	17.90	18.10	0.704	0.712
F	17.90	18.10	0.704	0.712
G	2.00	n/a	0.078	n/a
Н	1.50	1.60	0.059	0.062

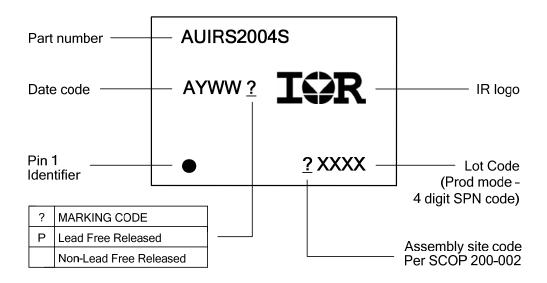


REEL DIMENSIONS FOR 44PLCC

	Me	tric	lmp	erial
Code	Min	Max	Min	Max
Α	329.60	330.25	12.976	13.001
В	20.95	21.45	0.824	0.844
С	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	38.4	n/a	1.511
G	34.7	35.8	1.366	1.409
Н	32.6	33.1	1.283	1.303

<sup>\*</sup> Qualification standards can be found on IR's web site www.irf.com

## **Part Marking Information**



#### **Ordering Information**

Daga Dant Manulage	Danks as True	Standard Pack		Commission Bout Name on
Base Part Number	Package Type	Form	Quantity	Complete Part Number
AUIRS2004S	SOIC8	Tube/Bulk	95	AUIRS2004S
A011\320043	33.33	Tape and Reel	2500	AUIRS2004STR



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## **Revision History**

Date	Comment
Jul. 30, 2010	Converted from industrial datasheet
Aug. 30, 2010	Update qualification ESD/LU class
Aug. 31, 2010	Changed Deadtime typical to 700nS on 1 <sup>st</sup> page, TON max to 880, MT max to 150, 60, DT min to 400, typ to 600. Added tri-temp graph, I/O equivalent circuit. Modified block diagram, SD pull up now.
Sep. 19, 2010	Typ Deadtime back to 520ns; DTmax=650ns at 25^C; DTmax=800ns; MT max to 150ns, (60ns at 25^C). ISD+ and ISD- parameters added to specify SD input impedance.
Sep. 28, 2010	Updated MT <sub>25</sub> to 80; updated block diagram and SD pin I/O circuit
Sep. 30, 2010	ISD+ and ISD- parameters exchanged because SD is pull down.
Oct. 14, 2010	Typ application section filled up
Oct. 19, 2010	Update reflow temp to 260C
Nov. 2, 2010	Changed 1 <sup>st</sup> page header. Minor update characteristics table format and corrected SD pin lead definition